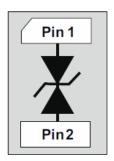




Single line ESD protection for high speed lines in 0402



SOD882T(0402) (QFN-2L 1.0 x 0.6 x 0.35)



Product status link

ESDAXLC6-1BT2

Features

- Flow-through routing to keep signal integrity
- Ultra large bandwidth: 12 GHz
- Ultra low capacitance: 0.4 pF
- Extended operating junction temperature range: -55 °C to 150 °C
- RoHS compliant
- Complies with IEC 61000-4-2 C = 150 pF, R = 330 Ω
 - ±16 kV (contact discharge)
 - ±30 kV (air discharge)

Application

The ESDAXLC6-1BT2 is a bidirectional single line TVS diode designed to protect the data line or other I/O ports against ESD transients such as:

- Digital video interface
- Ethernet
- USB 2.0 and USB 3.0
- · High speed communication buses
- RF front-end

Description

The ESDAXLC6-1BT2 is an ESD device designed for high-speed lines protection.

For automotive application, an AEC-Q101 qualified version is available see ESDAXLC6-1BT2Y.



1 Characteristics

Table 1. Absolute maximum ratings (T_{amb} = 25 °C)

Symbol		Value	Unit	
		IEC 61000-4-2 (C = 150 pF, R = 330 Ω):		
V_{PP}	Peak pulse voltage	Contact discharge	16	kV
		Air discharge	30	
P _{PP}	Peak pulse power dissipat	40	W	
I _{PP}	Peak Pulse current (8/20 µs)		1.3	Α
T _{stg}	Storage temperature range	-65 to +150	°C	
Tj	Operating junction tempera	-55 to +150	°C	
TL	Maximum lead temperatur	260	°C	

Figure 1. Electrical characteristics (definitions)

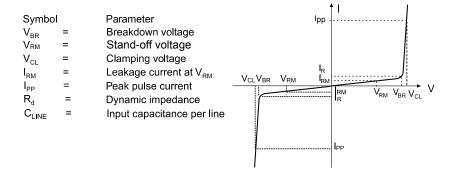


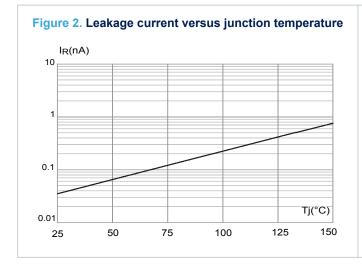
Table 2. Electrical characteristics (values) (T_{amb} = 25° C)

Symbol	Test conditions	Min.	Тур.	Max.	Unit
V_{BR}	I _R = 1 mA		9	11	V
I _R	V _R = 3 V			50	nA
	I _{PP} = 1 A, 8/20 μs			17	
V _{CL}	IEC 61000-4-2 - C = 150 pF, R = 330 Ω +8 kV contact discharge, measured at 30 ns		37		V
	TLP, pulse duration 100 ns, 16 A		41		
R _d	TLP, pulse duration 100 ns, 16 A		2		Ω
C _{I/O-GND}	V _{I/O} = 0 V, 200 MHz < f < 3 GHz, V _{OSC} = 30 mV		0.4	0.5	pF
f _C	$S_{21} = -3 \text{ dB}$		12		GHz

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1.1 Characteristics (curves)



C(pF)

0.8

0.7

0.6

0.5

0.4

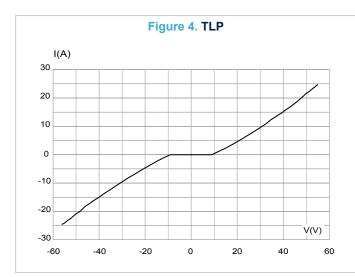
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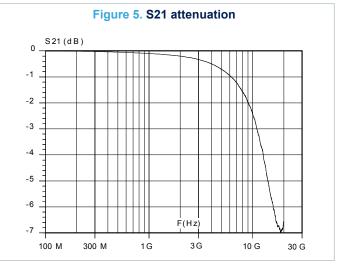
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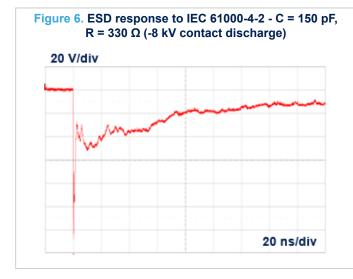
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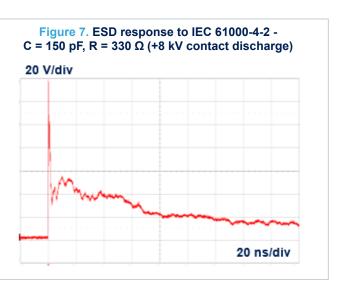
0.0

1 2 3 4 5









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Figure 8. H2 harmonic versus input power at 710 MHz

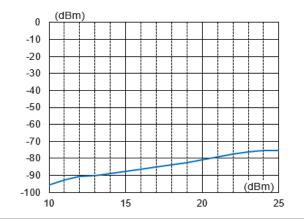


Figure 9. H3 harmonic versus input power at 710 MHz

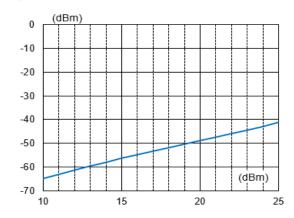


Figure 10. H2 harmonic versus input power at 824 MHz

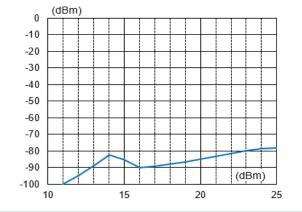


Figure 11. H3 harmonic versus input power at 824 MHz

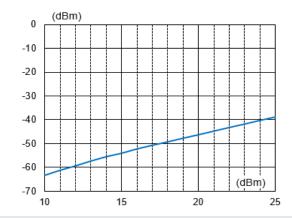


Figure 12. H2 harmonic versus input power at 2400 MHz

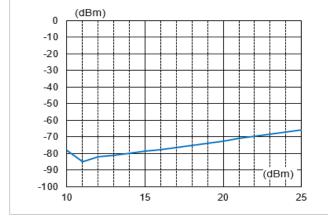
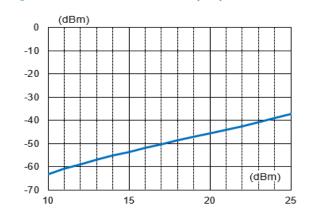


Figure 13. H3 harmonic versus input power at 2400 MHz



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Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 Package information

Figure 14. Package outline

Table 3. Package mechanical data

	Dimensions					
Ref.	Millimeters					
	Min.	Тур.	Max.			
A	0.30		0.40			
A1	0.00		0.05			
L1	0.45	0.50	0.55			
L2	0.45	0.50	0.55			
D	0.95	1.00	1.05			
E	0.55	0.60	0.65			
е	0.60	0.65	0.70			
b1	0.20	0.25	0.30			
b2	0.20	0.25	0.30			

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2.2 Packing and marking information

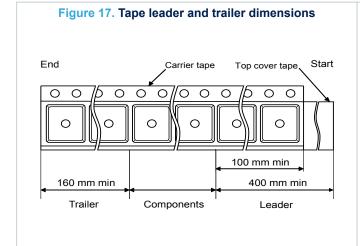
Figure 15. Marking layout

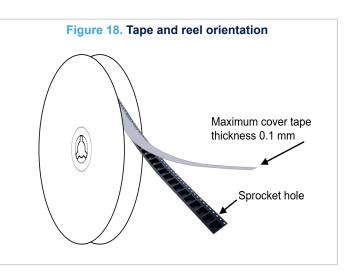
Figure 16. Package orientation in reel

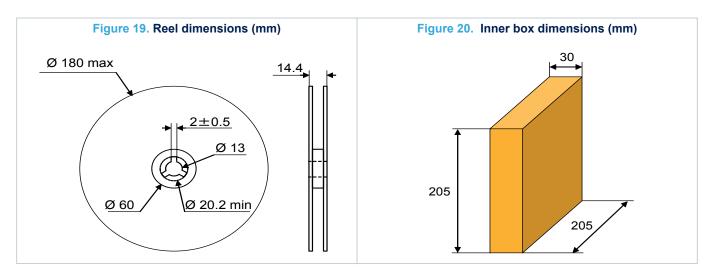
Figure 16. Package orientation in reel

Taped according to EIA-481

Note: Pocket dimensions are not on scale Pocket shape may vary depending on package On bidirectional devices, marking and logo may be not always in the same direction



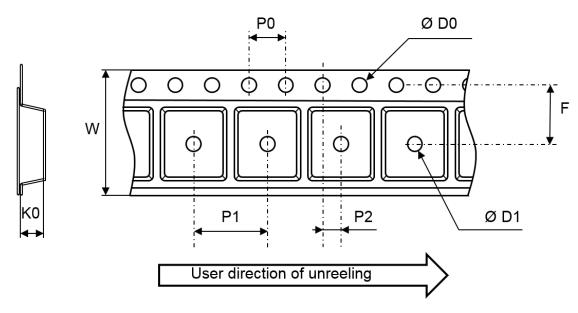




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Figure 21. Tape outline



Note: Pocket dimensions are not on scale Pocket shape may vary depending on package

Table 4. Tape and reel mechanical data

	Dimensions Millimeters				
Ref.					
	Min.	Тур.	Max.		
D0	1.45	1.5	1.6		
D1	0.35				
F	3.45	3.5	3.55		
K0	0.42	0.47	0.52		
P0	3.9	4	4.1		
P1	1.95	2	2.05		
P2	1.95	2	2.05		
W	7.9	8	8.3		

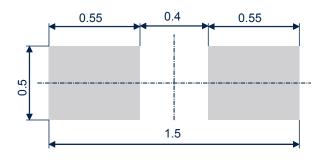
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3 Assembly recommendations

3.1 Recommended footprint

Figure 22. Recommended footprint in mm

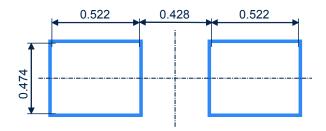


Note: Solder mask defined (SMD) recommended.

3.2 Stencil opening design

Stencil opening thickness: 75 µm / 3 mils

Figure 23. Stencil opening recommendations



3.3 Solder paste

- 1. Halide-free flux, qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste recommended.
- 3. Tack force high enough to resist component displacement during PCB movement.
- 4. Particles size 20-38 μm per IPCJ STD-005.

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3.4 Placement

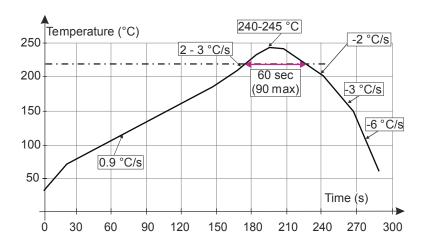
- It is recommended to use leads recognition instead of package outline for accurate placement on footprint with adequate resolution tool.
- 2. Tolerance of ±50 µm (25% offset allowed on the smallest dimension of the smallest pad) is recommended.
- 3. 1.0 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 4. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

3.5 PCB design preference

- 1. Any via around or inside the footprint area must be closed to avoid solderpaste migration in the via.
- Position and dimensions of the tracks should be well balanced. A symmetrical layout is recommended to prevent assembly troubles.

3.6 Reflow profile

Figure 24. ST ECOPACK recommended soldering reflow profile for PCB mounting



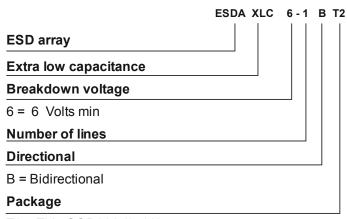
Note: Minimize air convection currents in the reflow oven to avoid component movement. O₂ rate inside the oven must be below 500 ppm. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

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4 Ordering information

Figure 25. Ordering information scheme



T2 = Thin SOD882 (0402)

Table 5. Ordering information

Order code	Marking ⁽¹⁾	Package	Weight	Base qty.	Delivery mode
ESDAXLC6-1BT2	Т	SOD882T (0402)	0.80 mg	12000	Tape and reel

1. The marking can be rotated by multiples of 90° to differentiate assembly location

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Revision history

Table 6. Document revision history

Date	Version	Changes
04-Sep-2012	1	Initial release.
12-Aug-2013	2	Updated Figure 4, Figure 5, Figure 6, Figure 11 and Table 4.
10-May-2021	3	Updated SOD882T (0402) package information.
10-May-2021		Minor text changes.

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ESD119B1W01005E6327XTSA1 ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF 3.0SMCJ33CA-F
3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7 SCM1293A-04SO
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82356240030 VESD12A1A-HD1-GS08 CPDUR5V0R-HF CPDUR24V-HF CPDQC5V0U-HF CPDQC5V0USP-HF CPDQC5V0-HF
D1213A-01LP4-7B D1213A-02WL-7 ESDLIN1524BJ-HQ 5KP100A 5KP15A